DECLARATION

AS A BELOW NAMED INVENTOR, I hereby declare that:

My residence, post office address and citizenship are as stated next to my name.

I believe that I am the original, first and sole (if only one name is listed below), or an original inventor (if plural names are listed below), of the subject matter which is claimed and for which a patent is sought on the invention entitled:

United States below and, in or PCT Inte acknowledge Regulations, international	nsofar as the subject r ernational application(the duty to disclose	natter of each of the claims of thi (s) in the manner provided by e information material to patent me available between the filing	s application is not disclosed in the first paragraph of Title 35, ability as defined in Title 37, date of the prior application and	he prior Unit U.S. Code, The Code of I the national	ed States §112, I Federal or PCT
United States below and, in or PCT Inte acknowledge Regulations,	nsofar as the subject remational application(the duty to disclose §1.56(a) which beca	natter of each of the claims of thi (s) in the manner provided by e information material to patent me available between the filing	s application is not disclosed in the first paragraph of Title 35, ability as defined in Title 37, I	he prior Unit U.S. Code, The Code of	ed States §112, I Federal
	eby claim the benefit	under Title 35, U.S. Code, §120 on(s), or §365(c) of any PCT Inter	of any United States application	(s), or §119(e) of any
(Application N		(Country)	(Day/Month/Year filed)		
2002-5568 (Application N	lumber)	Korea (Country)	13 September 2002 (Day/Month/Year filed)		No []
				Priority (
claims, as am to patentabili §1.56. I here for patent or i than the Unite	nended by any amendr ity and to the examina by claim foreign prior inventor's certificate, of ed States, listed below	nent referred to above. I acknow ation of this application in according the benefits under Title 35, U.S. Cor §365(a) of any PCT internations	ents of the above-identified specification in the design and the duty to disclose informal ance with Title 37 of the Code of Code §119(a)-(d) or §365(b) of any all application which designated at 1 y foreign applications for patent or is claimed:	tion which is f Federal Reg foreign appli east one coun	material gulations ication(s) atry other
and (if ap	pplicable) was amendo	ed on			_,
☐ was filed			and assigned Serial No		,
	tion of which either is	attached hereto or indicates an a	ttorney docket no. 8021-165 (SS-	17922-US),	or:
the specificat					

I hereby appoint the following attorneys: FRANK CHAU, Reg. No. 34,136; FRANK V. DeROSA, Reg. No. 43,584; NATHANIEL T. WALLACE, Reg. No. 48,909; ERIC M. PARHAM, Reg. No. 45,747; GEORGE D. MORGAN, Reg. No. 46,505; MICHAEL J. PORCO, Reg. No. 46,007; LEONARD B. TAYLOR, Reg. No. 50,376; and THOMAS W. McNALLY, Reg. No. 48,609; each of them of F. CHAU & ASSOCIATES, LLP, 1900 Hempstead Turnpike, Suite 501, East Meadow, New York 11554 to prosecute this application and to transact all business in the U.S. Patent and Trademark Office connected therewith and with any divisional, continuation, continuation-in-part, reissue or reexamination application, with full power of appointment and with full power to substitute an associate attorney or agent, and to receive all patents which may issue thereon, and request that all correspondence be addressed to:

Frank Chau, Esq. F. CHAU & ASSOCIATES, LLP 1900 Hempstead Turnpike, Suite 501 East Meadow, New York 11554 Area Code: 516-357-0091 I HEREBY DECLARE that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under §1001 of Title 18 U.S. Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

FULL NAME OF FIRST OR SOLE	Citizenship KOREA	
Inventor's signature:	D-V. Cee	Date: Aug. 30. 200
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